

**Amendments to the Specification:**

**At page 9, the paragraph beginning line 7 to line 8, is to be amended as follows:**

The ink jet printhead chip 52 (see Fig. 6) includes a silicon wafer substrate 8015. 0.35  
Micron 1 P4M 12 volt CMOS microprocessing circuitry is positioned on the silicon wafer  
substrate 8015.